

Ti Application Note No. T- 21

Title:	Sn(II) and sulphuric acid in tin plating bath
TILIC.	Single and Sulphuric acid in the plating Satir

Summary: Determination of Sn(II) and sulphuric acid in an acidic tin plating bath by potentiometric titration.

Sample: Acidic tin plating bath

Sample

Preparation: none, see under «Analysis»

Instruments and

Accessories: 702, 716 or 736 Titrino or 726 Titroprocessor,

6.0431.100 Pt Titrode and 6.0219.100 combined glass electrode

Analysis: Determination of Sn(II):

Pipette a corresponding sample volume into a beaker, add 50 mL oxygen-free dist. water and titrate under nitrogen with $c(l_2) = 0.05$ mol/L using the Pt Titrode.

Determination of H₂SO₄:

Pipette 2.00 mL sample into a beaker, add 50 mL $BaCl_2$ solution and titrate with c(NaOH) = 1 mol/L using the combined glass electrode.

Calculation: g/L Sn(II) = EP1 * C01 / C00

 $g/L H_2SO_4 = EP1 * C02 / C00$

EP1 = titrant consumption in mL

C00 = sample size in mL

C01 = 5.9345 (Sn(II) equivalent in mg/mL; 1 mL $c(l_2)$ = 0.05 mol/L

corresponds to 5.9345 mg Sn(II))

C02 = 49.037 (H₂SO₄ equivalent in mg/mL; 1 mL c(NaOH) = 1

mol/L corresponds to 49.037 mg H₂SO₄)

Remarks: If Sn(IV) also has to be determined the sample solution is prepared

as follows:

Pipette a corresponding sample volume into a beaker, add 40 mL $c(H_2SO_4) = 2$ mol/L and ca. 0.1 g Al powder and stir until the Al has completely dissolved, then titrate as described under «Determination of Sn(II)». The hydrogen produced in this way reduces all the Sn(IV) to the divalent state.